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Development of High Sensitivity CMOS-MEMS Inertia Sensor and its Application to Early-Stage Diagnosis of Parkinson's Disease

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Abstract—In this paper, we present our recent progress of a high sensitivity complementary metal-oxide semiconductor-microelectromechanical systems (CMOS-MEMS) inertia sensor and its application to early-stage diagnosis of Parkinson's disease. The feature of the CMOS-MEMS sensor is the use of gold proof mass. High density of gold enables us to increase sensitivity by reducing thermo-mechanical noise that is inversely proportional to proof mass. We then show the developed CMOS-MEMS multi-physics design environment. An equivalent circuit of a MEMS accelerometer has been designed to simultaneously understand both the mechanical and the electrical behaviors. One of the potential applications of the high sensitivity inertia sensor is also discussed by focusing on early-stage diagnosis of Parkinson's disease.

Keywords—CMOS-MEMS; gold proof mass; inertia sensor; multi-physics design environment; Parkinson's disease

I. INTRODUCTION

Microelectromechanical systems (MEMS) inertia sensors, such as MEMS accelerometers, are now widely used for a variety of applications as seen in automotive, industrial, healthcare, entertainment, consumer handheld electronics, and so forth [1]. The driving force behind the continuous performance improvement of MEMS inertia sensors is the development of silicon MEMS technology [2] with the use of surface micromachining process in combination with capacitive sensing methods [3]. The MEMS technology has enabled us to miniaturize all the mechanical components down to micro-meter scale and to reduce production cost by taking advantage of semiconductor manufacturing process.

Today, commercial MEMS inertia sensors accommodate typically more than 1 G ($1\text{ G} = 9.8\text{ m/s}^2$: gravitational acceleration). On the other hand, accurate sub-1G sensing by using MEMS inertial sensors has potential to realize various unexplored applications, such as precise monitoring of human and non-human objects for healthcare and medical purposes or integrated inertial measurement unit for advanced navigation systems [4].

So far, several MEMS accelerometers have been proposed to sense such a sub-1G range [5, 6], where they utilize a large-sized silicon proof mass to reduce the thermal-mechanical

noise, namely Brownian noise (B_N). Such an approach would increase the MEMS device footprint and thereby the manufacturing cost.

In this paper, we first present our recent research progress of a high sensitivity CMOS-MEMS inertia sensor. Next, we show our CMOS-MEMS multi-physics design environment that enables to simulate both the mechanical and the electrical behavior of the inertia sensor. Lastly, a possible application of the inertia sensor is discussed in terms of early-stage diagnosis of Parkinson's disease.

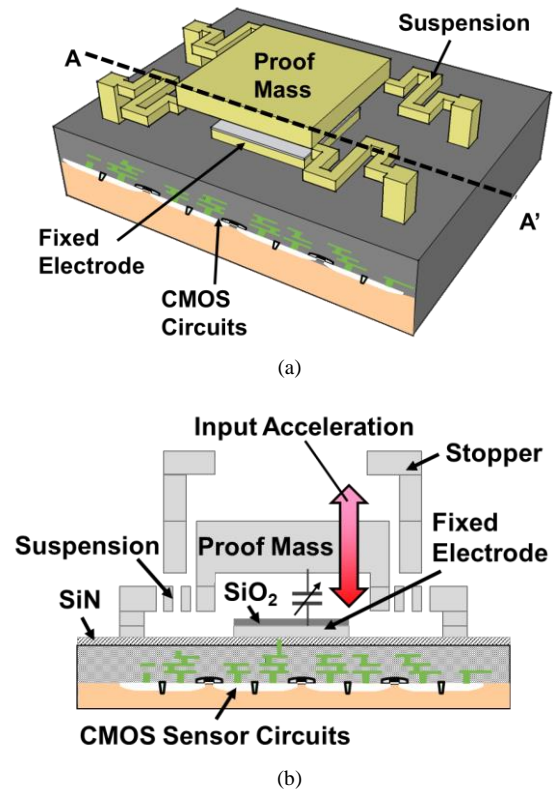


Fig. 1. Conceptual cross section of CMOS-MEMS accelerometer. (a) Bird-eye view and (b) cross-section image.

II. HIGH SENSITIVITY INERTIA SENSOR USING GOLD AS PROOF-MASS

Figure 1 shows the conceptual image of the developed CMOS-MEMS inertia sensor. The MEMS structure is fabricated onto standard CMOS wafer using so-called post-CMOS process [7]. The feature of the MEMS device is the use of a gold proof mass, which contributes to reduce the B_N in the inertia sensor. The B_N of moving structures determines the sensitivity of MEMS accelerometer. B_N is expressed as

$$B_N = \frac{\sqrt{4k_B T b}}{m} \quad (1)$$

where k_B , T , b and m are the Boltzmann constant (1.38×10^{-23}

J/K), the absolute temperature, the viscous damping coefficient and the mass of the movable structures of an inertial sensor, respectively. From eq. (1), increasing the density of the proof mass is an effective and straightforward way to suppress the B_N without compromising the device footprint. The reason of the use of gold is that the density of Au ($19.3 \times 10^3 \text{ kg/m}^3$ at RT) is nearly an order of magnitude higher than that of Si ($2.33 \times 10^3 \text{ kg/m}^3$ at RT) [8] used as a standard material of proof mass.

Figure 2 is a fabricated sub-1G inertia sensor with the scanning electron microscope (SEM) images. The designed B_N was $0.12 \text{ } \mu\text{G/Hz}^{1/2}$. From the measured values of the mechanical resonant frequency and the mechanical Q, B_N was estimated to be below $1 \text{ } \mu\text{G/Hz}^{1/2}$, which was sufficiently below the target value of $10 \text{ } \mu\text{G/Hz}^{1/2}$ [9, 10]. We also confirmed that the sub-1G MEMS inertia sensor can function without mechanical failure after the input acceleration of up to 20 G [11], as shown in Fig. 3.

The gold layer which was used for the MEMS inertia sensor were deposited by electroplating method. Ti/Au cantilevers were fabricated for evaluating the structure stability as shown in Fig. 4 [12, 13]. Clear vending was not observed in even $3\text{ }\mu\text{m}$ -thick \times $10\text{ }\mu\text{m}$ -wide with $1,000\text{ }\mu\text{m}$ -long cantilever.

The mechanical properties such as yield strength, Young modulus, stability, *etc.* are important parameters for designing MEMS structures. High mechanical properties of nano-crystalline Au have been investigated [14][15].

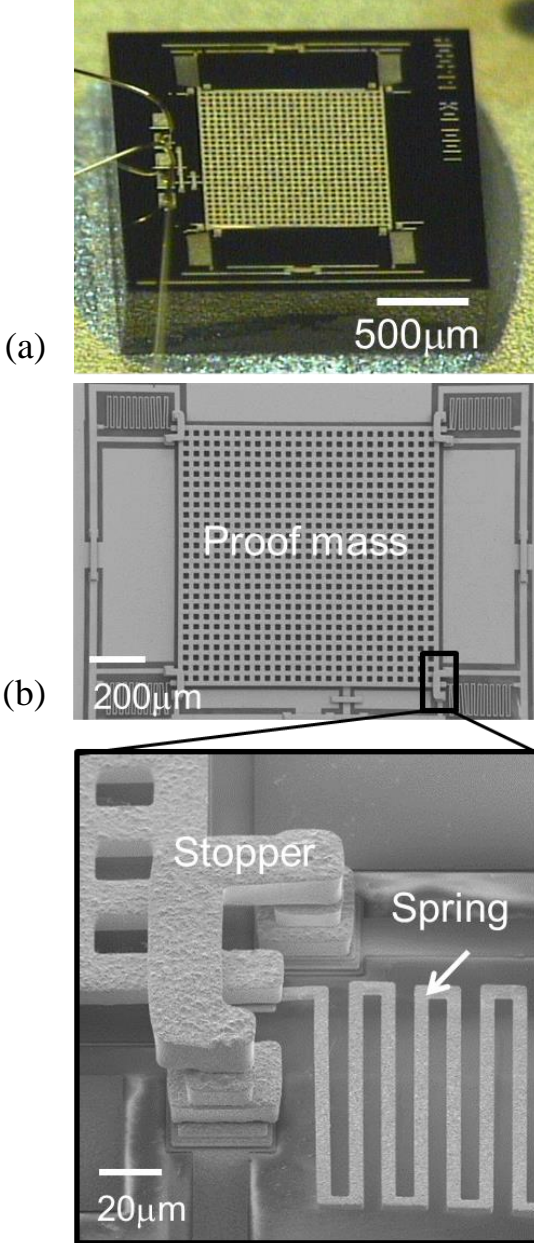


Fig. 2. Sub-1G MEMS inertia sensor with a high-density proof mass [10]. (a) Chip photo and (b) SEM images. The thickness of Au proof mass is $12 \text{ }\mu\text{m}$.

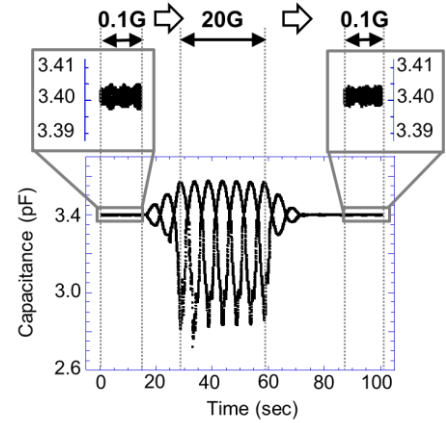


Fig. 3. Measured capacitance response of sub-1G sensor at the input acceleration from 0.1 G to 20 G [12].

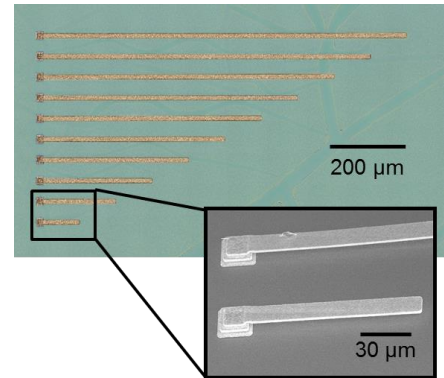


Fig. 4. Ti/Au multi-layer metal micro cantilevers with $3\text{ }\mu\text{m}$ -thick Au [12].

Three types of electroplating Au film were prepared. (1) the conventional constant-current electroplating (CE) using a cyanide-based electrolyte, (2) CE using sulfite-based electrolyte, and (3) the pulse electroplating (PE) with a sulfite-based electrolyte. After the electroplating, micro-pillars were made from the Au films by focused ion beam milling. Dimensions of the fabricated pillars were $10\mu\text{m} \times 10\mu\text{m} \times 20\mu\text{m}$.

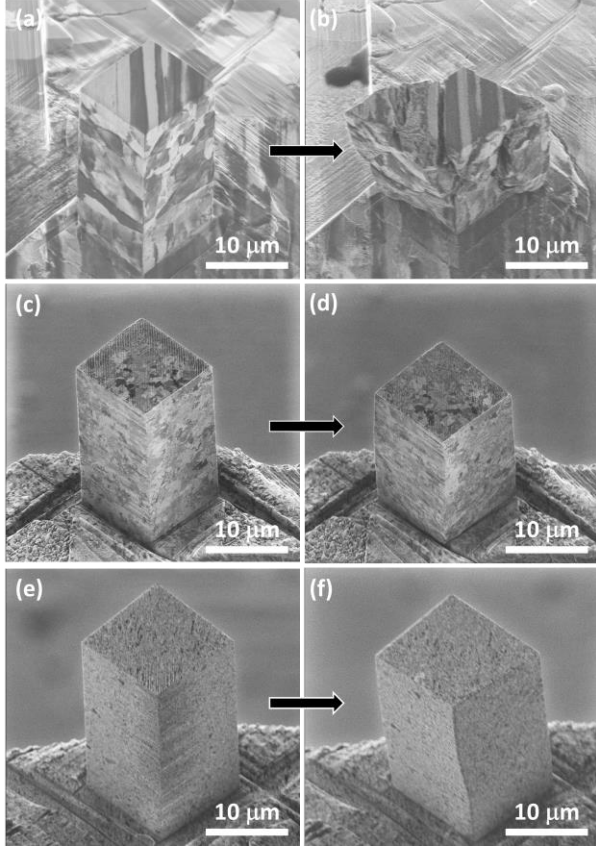
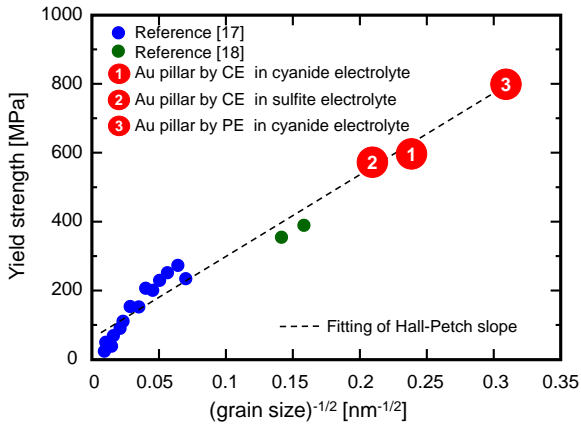


Fig. 5 SIM images of the (a) as-fabricated and (b) deformed Au pillars fabricated from the CE with the cyanide-based electrolyte, the (c) as-fabricated and (d) deformed Au pillars fabricated from the CE with the sulfite-based electrolyte, and the (e) as-fabricated and (f) deformed Au pillars fabricated from the PE with the sulfite-based electrolyte. [14]



the velocity and displacement x of proof mass as a result of impinging force, and v) and anchor module to fix the mechanical ends. These modules are described by a Verilog-A compatible hardware description language (HDL). Multi-physics simulation is performed by SPICE on usual LSI design environments. CMOS and MEMS layouts are also designed on the multi-physics design environment.

Figure 8 is an example of CMOS-MEMS co-simulation and measurement results. The output voltages as a function of the input acceleration were obtained by multi-physics simulation and experiments. The behavior model had a good agreement with the experimental results for the input acceleration of 3 G or lower. For the input acceleration of 3 G or larger, notable

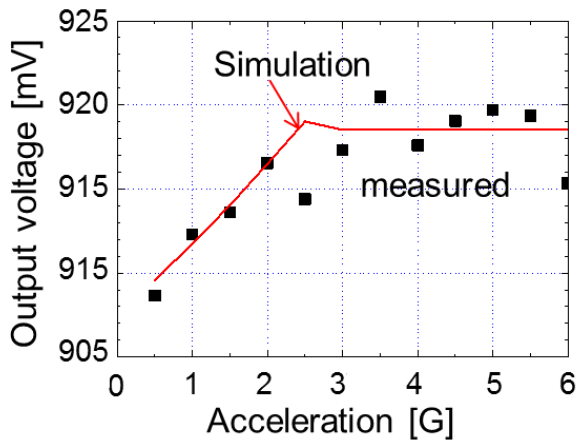


Fig. 8. CMOS-MEMS multi-physics simulation. MEMS inertia sensor on 0.35 μm standard CMOS [14].

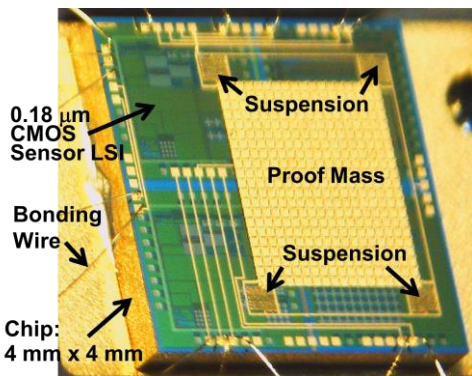


Fig. 9. Chip photo of CMOS-MEMS integrated inertia sensor [20].

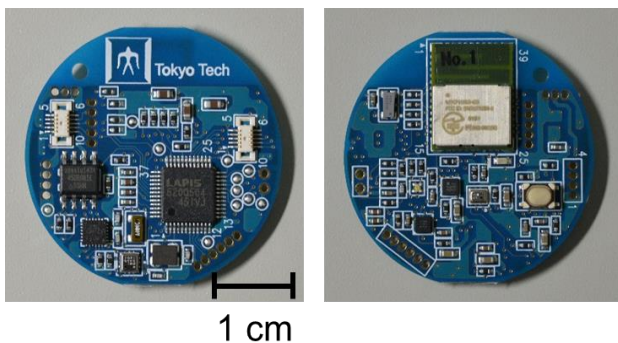


Fig. 10. A sensor module with Bluetooth low energy wireless communication.

deviations were found in the experimental results possibly due to excess mechanical motion of the proof mass ramming in the suspensions and the substrate. Figure 9 is a photo of a recently developed CMOS-MEMS inertia sensor [20]. The sensor LSI was fabricated with 0.18- μm CMOS process, and the MEMS structures were successfully implemented onto the LSI chip with the footprint of $4 \times 4 \text{ mm}^2$ by the post-CMOS process [7].

Lately, we have developed sensor module using Bluetooth low energy as shown in Fig. 10. The several sensors such as temperature, pressure, accelerometer, gyroscope and so forth, are integrated on the module. This small size module is used for human motion sensing. The high sensitivity inertia sensor will be implemented on this module.

IV. EARLY STAGE DIAGNOSIS OF PARKINSON'S DISEASE

Parkinson's disease is originated from lack of dopamine secretion. Early-stage diagnosis enables the delay of symptom progress and/or the interval extension of Levodopa dosing, resulting in quality-of-life (QoL) improvement of Patient. Parkinson's disease is categorized by Hoehn-Yahr (HY) scale as shown in Fig. 11. We have reported HY2-3 diagnosis from the analysis of walking period with around 80 % accuracy [21-29]. In this paper, preliminary results of earlier diagnosis using inertia sensors in terms of patients' postural reflex failure.

Postural abnormality is one of the symptoms of Parkinson's disease. X-ray image, floor reaction sensor and motion capture system are used to evaluate this. Estimation postural angle by using compact accelerometers yields benefits that it reduces environmental limit and realizes lifelog. Therefore, we developed quantitative evaluation system using accelerometers for postural abnormality in Parkinson's disease. The proposal

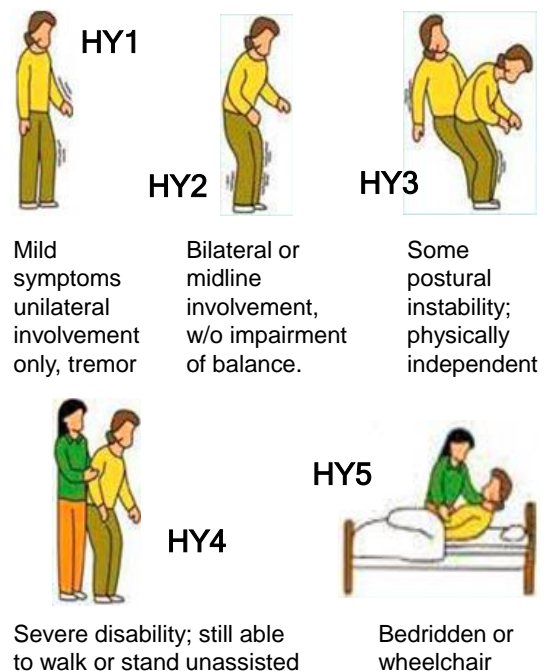


Fig. 12. Hoehn-Yahr (HY) scale of Parkinson's disease.

system is composed of postural angle estimation, postural feature extraction and PD classification.

The proposal system consists of two sensor modules. The patients wear one of the sensor on 10cm below C7 vertebra and the other on L4 vertebra. Postural angles of each sensor are estimated by the gravity components of accelerations. The algorithm is summarized in Fig. 12.

17 healthy young people, 17 healthy elderly people, 19 mild PD, HY 1-2, patients and 24 severer PD, HY 2.5-4, patients were participated in this experiment. All participants' postural angles were measured under 3 conditions, sitting, standing and walking by the proposal system. The result under the standing condition is shown in Fig.13.

150 features such as range, average, variance and skewness are extracted from measured accelerations data. To find effective features for PD classifier, we compared the features of each group, healthy young, healthy elderly, mild PD and severe PD. 41 features are significant difference ($p < 0.01$, Kruskal-Wallis test). Figure 14 shows the result of comparison.

Finally, we constructed classifiers by using these feature values. In this work, Support Vector Machines are used for classification. Cross-validation is used to verify the constructed classifiers. The result shown in Table I. We will continue the earlier diagnosis in terms of patients' tremor (vibration of fingers and hands) using high-sensitivity inertia sensors.

V. CONCLUSION

We presented our recent progress of a high sensitivity CMOS-MEMS inertia sensor and discussed the sensor application to the diagnosis of Parkinson's disease. The experiment results show the inertia sensor has high potential for sensing sub-1G acceleration. The preliminary earlier diagnosis using inertia sensors was demonstrated. We then conclude that the proposed high sensitivity inertia sensor can be a key component to realize early-stage diagnosis system for Parkinson's disease.

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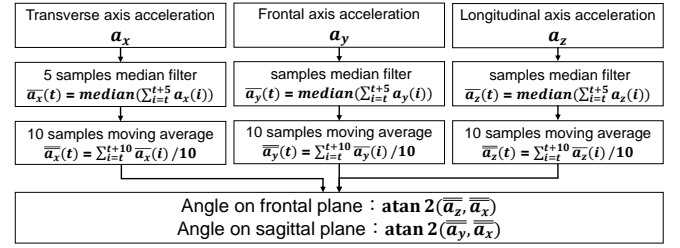


Fig. 12. The algorithm to estimate postural angles from acceleration data.

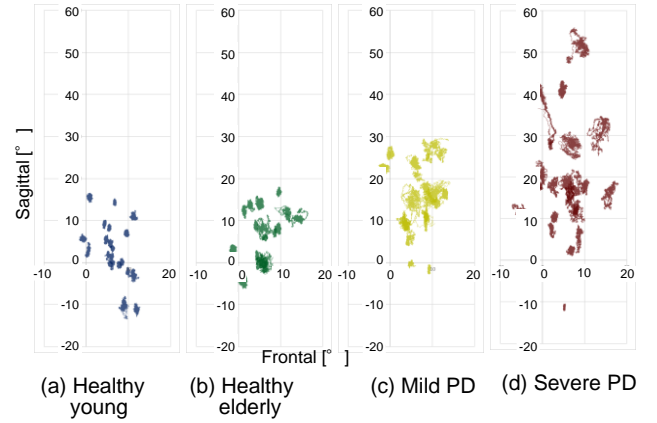


Fig. 13. Postural angles of 10cm below C7 during 30sec under the standing condition of each participant.

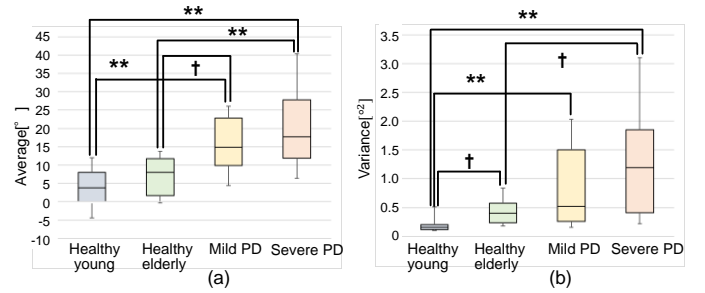


Fig. 14. Postural feature values. (a) Average of sagittal angle on 10cm below C7. (b) Variance of sagittal angle on 10cm below C7. † : $p < 0.1$, * : $p < 0.05$, ** : $p < 0.01$, Steel-Dwss test.

TABLE I. THE CLASSIFIER'S ACCURACY EVALUATED BY CROSS-VALIDATION

	Accuracy [%]
Severe PD-Mild PD	81.0
Severe PD-Healthy Elderly	90.0
Mild PD-Healthy Elderly	77.8
Severe PD-Healthy Young	92.9
Mild PD-Healthy Young	89.5
Healthy Elderly-Healthy Young	80.6

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